

#### 4.0x4.0mm RIGHT ANGLE SURFACE MOUNT **LED LAMP**

Part Number: KA-4040SESK

Super Bright Orange

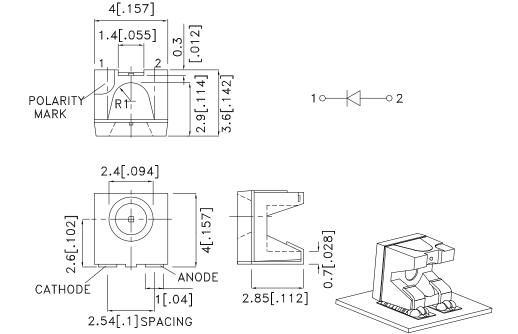
#### **Features**

- Single color.
- Suitable for all SMT assembly and solder process.
- Available on tape and reel.
- Ideal for backlighting.
- Package: 500pcs / reel.
- Moisture sensitivity level : level 3.
- RoHS compliant.

#### Description

The Super Bright Orange device is made with AlGaInP (on GaAs substrate) light emitting diode chip.

### **Package Dimensions**



- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is  $\pm 0.25(0.01")$  unless otherwise noted.
- The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
   The device has a single mounting surface. The device must be mounted according to the specifications.





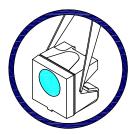
SPEC NO: DSAK9798 **REV NO: V.3 DATE: JAN/31/2011** PAGE: 1 OF 6 APPROVED: WYNEC **CHECKED: Allen Liu** DRAWN: Y.F.Lv ERP: 1201006829

### **Handling Precautions**

Compare to epoxy encapsulant that is hard and brittle, silicone is softer and flexible. Although its characteristic significantly reduces thermal stress, it is more susceptible to damage by external mechanical force.

As a result, special handling precautions need to be observed during assembly using silicone encapsulated LED products. Failure to comply might lead to damage and premature failure of the LED.

1. Handle the component along the side surfaces by using forceps or appropriate tools.



2. Do not directly touch or handle the silicone lens surface. It may damage the internal circuitry.





3. As silicone encapsulation is permeable to gases, some corrosive substances such as  $H_2S$  might corrode silver plating of leadframe. Special care should be taken if an LED with silicone encapsulation is to be used near such substances.

 SPEC NO: DSAK9798
 REV NO: V.3
 DATE: JAN/31/2011
 PAGE: 2 OF 6

 APPROVED: WYNEC
 CHECKED: Allen Liu
 DRAWN: Y.F.Lv
 ERP: 1201006829

### **Selection Guide**

Part No.	Dice	Lens Type	lv (mcd) [2] @ 20mA		Viewing Angle [1]
			Min.	Тур.	201/2
KA-4040SESK	Super Bright Orange (AlGaInP)	Water Clear	200	450	120°

- Notes: 1.  $\theta$ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value. 2. Luminous intensity/ luminous Flux: +/-15%.

### Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Super Bright Orange	610		nm	IF=20mA
λD [1]	Dominant Wavelength	Super Bright Orange	601		nm	IF=20mA
Δλ1/2	Spectral Line Half-width	Super Bright Orange	29		nm	IF=20mA
С	Capacitance	Super Bright Orange	15		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Super Bright Orange	2.1	2.5	V	IF=20mA
lr	Reverse Current	Super Bright Orange		10	uA	V <sub>R</sub> =5V

### Notes:

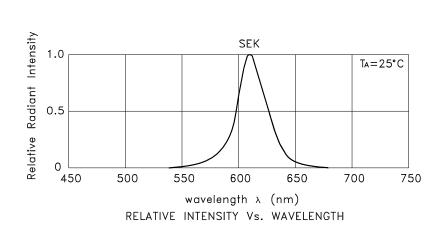
- 1.Wavelength: +/-1nm. 2. Forward Voltage: +/-0.1V.

#### Absolute Maximum Ratings at TA=25°C

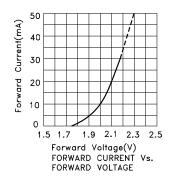
Parameter	Super Bright Orange	Units	
Power dissipation	75	mW	
DC Forward Current	30	mA	
Peak Forward Current [1]	195	mA	
Reverse Voltage	5	V	
Operating Temperature	-40°C To +85°C		
Storage Temperature	-40°C To +85°C		

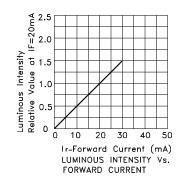
Note: 1. 1/10 Duty Cycle, 0.1ms Pulse Width.

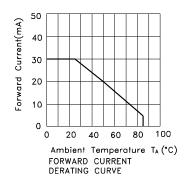
SPEC NO: DSAK9798 **REV NO: V.3** DATE: JAN/31/2011 PAGE: 3 OF 6 APPROVED: WYNEC **CHECKED: Allen Liu** DRAWN: Y.F.Lv ERP: 1201006829

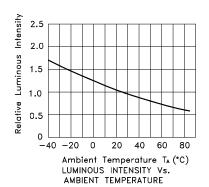


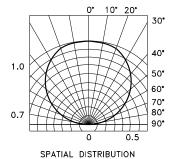
Super Bright Orange KA-4040SESK











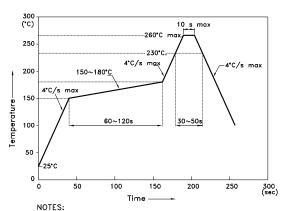
 SPEC NO: DSAK9798
 REV NO: V.3
 DATE: JAN/31/2011
 PAGE: 4 OF 6

 APPROVED: WYNEC
 CHECKED: Allen Liu
 DRAWN: Y.F.Lv
 ERP: 1201006829

#### KA-4040SESK

Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



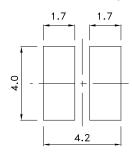
- NOTES:

  1.We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.

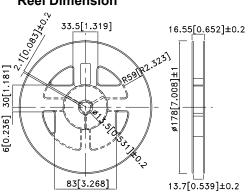
  2.Don't cause stress to the epoxy resin while it is exposed to high temperature.

  3.Number of reflow process shall be 2 times or less.

**Recommended Soldering Pattern** (Units: mm; Tolerance: ± 0.1)

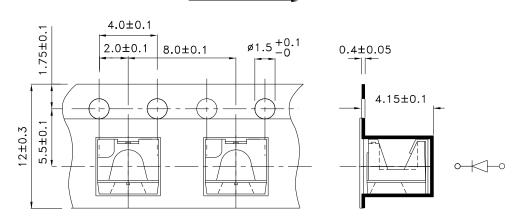


**Reel Dimension** 



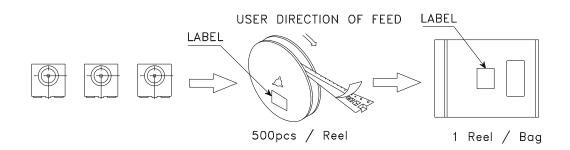
**Tape Dimensions** (Units: mm)

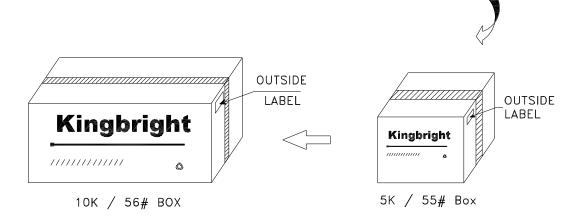
TAPE

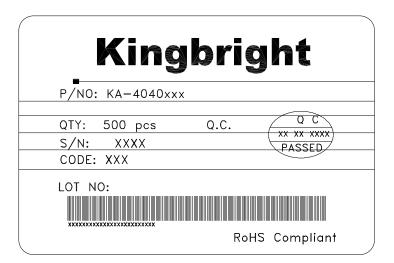


SPEC NO: DSAK9798 **REV NO: V.3 DATE: JAN/31/2011** PAGE: 5 OF 6 APPROVED: WYNEC CHECKED: Allen Liu DRAWN: Y.F.Lv ERP: 1201006829

#### **PACKING & LABEL SPECIFICATIONS** KA-4040SESK







SPEC NO: DSAK9798 APPROVED: WYNEC

**REV NO: V.3 CHECKED: Allen Liu**  DATE: JAN/31/2011 DRAWN: Y.F.Lv

PAGE: 6 OF 6 ERP: 1201006829